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Title of Invention	TUNABLE SEMICONDUCTOR DIODES							
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Steven H. Voldman</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: BUR920030097US1</p>								
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<table border="1"><thead><tr><th data-bbox="140 1044 813 1086">Submitted By:</th><th data-bbox="813 1044 1169 1086">Elec. Sign.</th><th data-bbox="1169 1044 1487 1086">Sign. Capacity</th></tr></thead><tbody><tr><td data-bbox="140 1086 813 1167">Richard A. Henkler Registered Number: 39,220</td><td data-bbox="813 1086 1169 1167">Richard A. Henkler /s/</td><td data-bbox="1169 1086 1487 1167">Attorney</td></tr></tbody></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Richard A. Henkler Registered Number: 39,220	Richard A. Henkler /s/	Attorney
Submitted By:	Elec. Sign.	Sign. Capacity						
Richard A. Henkler Registered Number: 39,220	Richard A. Henkler /s/	Attorney						

Documents being submitted:	Files
us-fee-sheet	BUR920030097US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-request	BUR920030097US1-usrequ.xml us-request.dtd us-request.xsl
us-assignment	BUR920030097US1-usassn.xml us-assignment.xsl us-assignment.dtd BUR920030097Assign1.tif BUR920030097Assign2.tif
us-declaration	BUR920030097dec1.tif
application-body	BUR920030097spec-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd BUR920030097drw1.tif BUR920030097drw2.tif BUR920030097drw3.tif BUR920030097drw4.tif BUR920030097drw5.tif BUR920030097drw6.tif
Comments	